



General Description

The SJS2301 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

Features

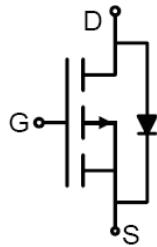
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

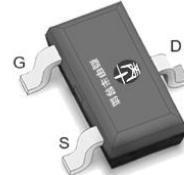
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	-20	V
$R_{DS(ON)}_TYP$	106	mΩ
I_D	-2.3	A
Q_G	9.1	nC



Schematic Diagram



SOT-23 top view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS2301	2301	SOT-23	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	-20	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 12	V
I_D	Drain Current-Continuous($T_A=25^\circ\text{C}$)	-2.3	A
	Drain Current-Continuous($T_A=100^\circ\text{C}$)	-1.3	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-8	A
P_D	Maximum Power Dissipation($T_A=25^\circ\text{C}$)	0.78	W
	Maximum Power Dissipation($T_A=100^\circ\text{C}$)	0.3	W
E_{AS}	Avalanche energy (Note 2)	5	mJ
T_J , T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		160	°C/W



20V P-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=-250\mu\text{A}$	-20			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			-1	μA
		$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			-100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 12\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	-0.5		-1	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$, $I_{\text{D}}=-1.5\text{A}$		4.4		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-1.5\text{A}$ $T_J=25^\circ\text{C}$		106	135	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=-2.5\text{V}$, $I_{\text{D}}=-1\text{A}$ $T_J=25^\circ\text{C}$		140	186.2	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=-10\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$		225		pF
C_{oss}	Output Capacitance			34		pF
C_{rss}	Reverse Transfer Capacitance			27		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$		47		Ω
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=-4.5\text{V}$, $V_{\text{DS}}=-10\text{V}$, $R_L=3.3\Omega$, $R_{\text{GEN}}=3\Omega$		11		nS
t_r	Turn-on Rise Time			34		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			55		nS
t_f	Turn-Off Fall Time			51		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=-4.5\text{V}$, $V_{\text{DS}}=-10\text{V}$, $I_{\text{D}}=-3\text{A}$		9.1		nC
Q_{gs}	Gate-Source Charge			1.6		nC
Q_{gd}	Gate-Drain Charge			2		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				-2.3	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=-3\text{A}$			-1.2	V

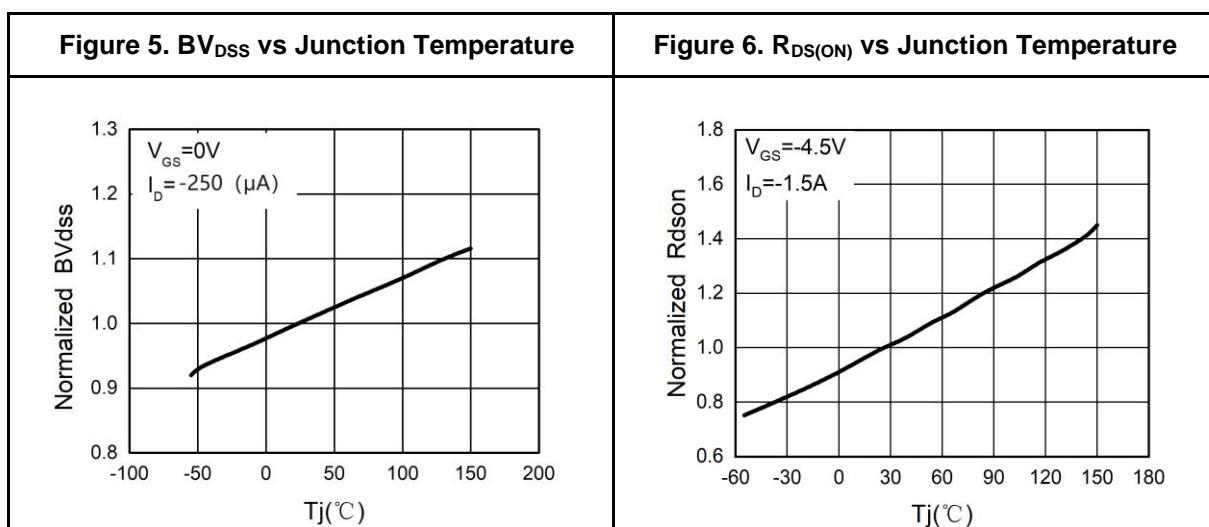
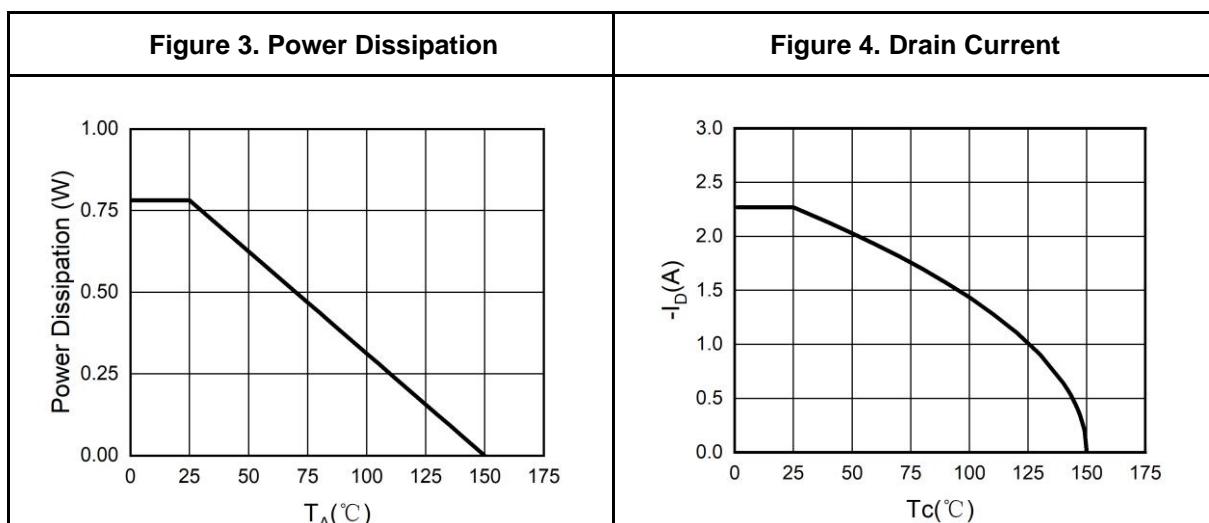
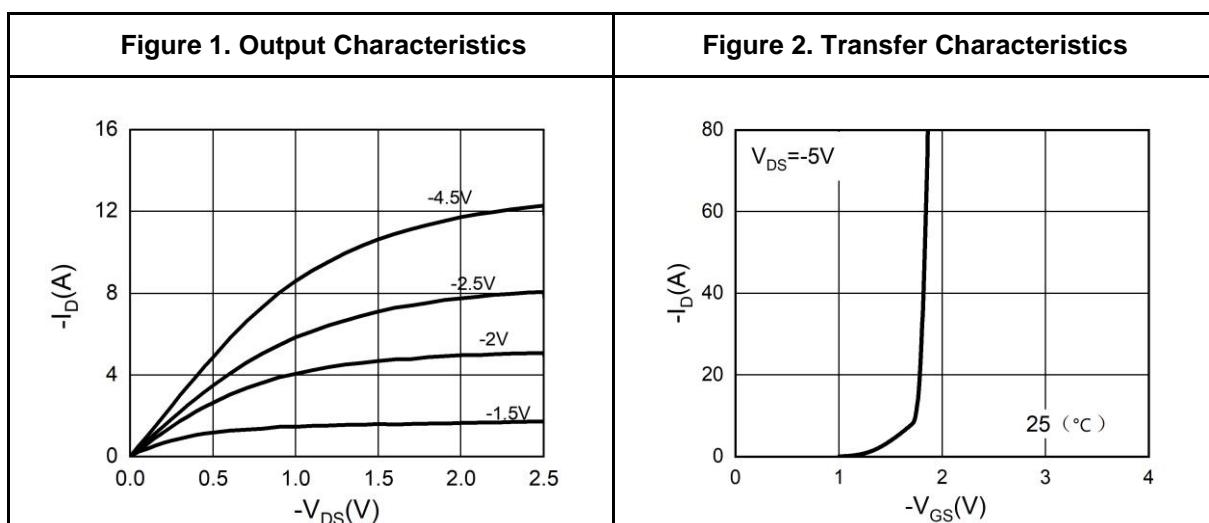
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_AS condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=-20\text{V}$, $V_{\text{G}}=-10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

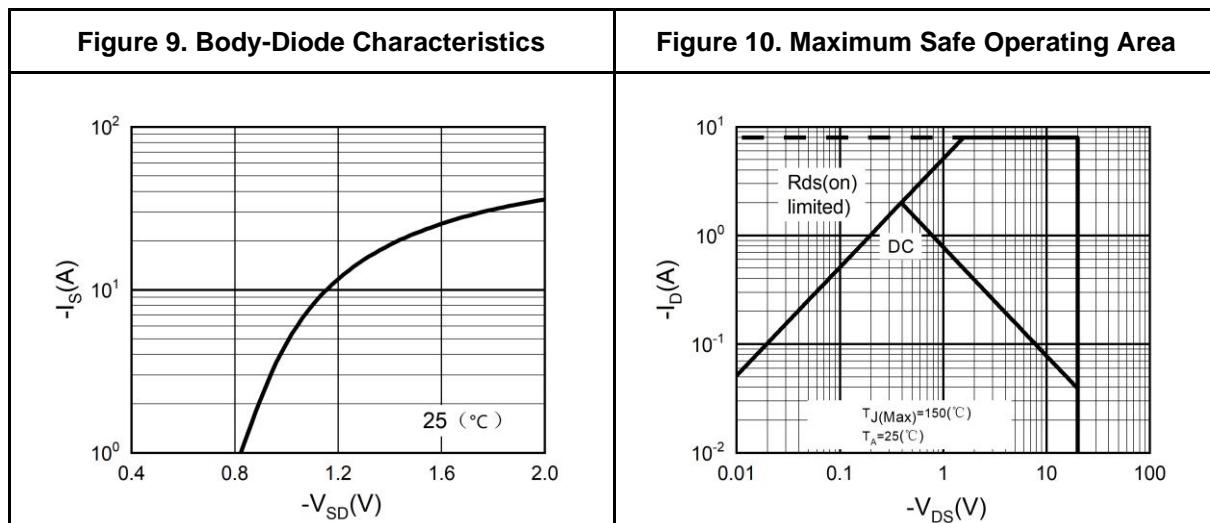
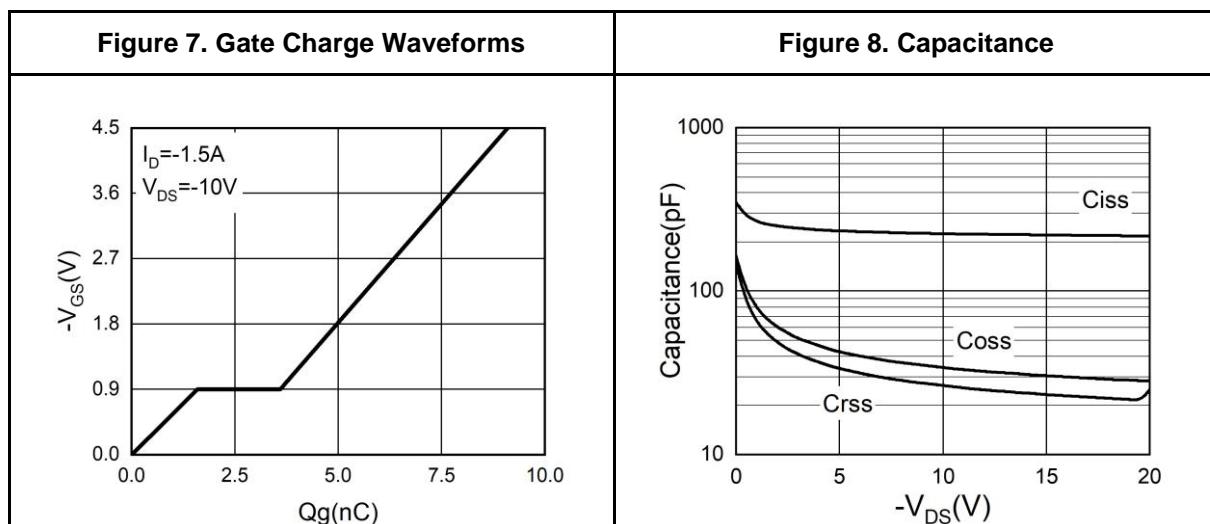


Typical Electrical And Thermal Characteristics (Curves)



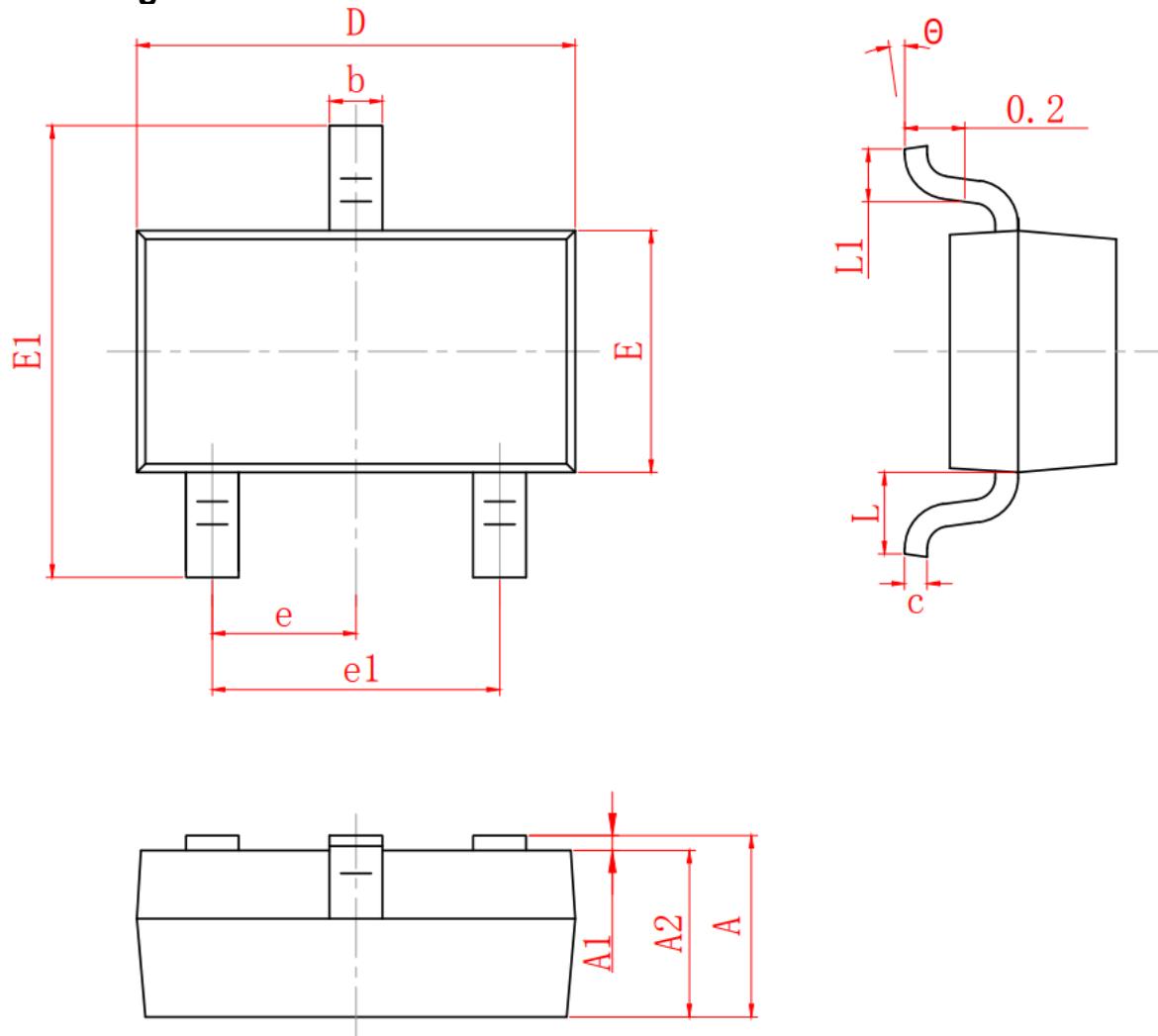


Typical Electrical And Thermal Characteristics (Curves)





SOT-23 Package Information



SYMBOL	MIN	NOM	MAX
A	0.90	1.05	1.20
A1	0.00	0.05	0.10
A2	0.90	1.00	1.10
b	0.30	0.40	0.50
c	0.08	0.10	0.15
D	2.80	2.90	3.00
E	1.20	1.30	1.40
E1	2.30	2.40	2.50
L	0.30	0.40	0.50
θ	0°	5°	10°
L1	0.55 REF		
e	0.95 BSC		
e1	1.90 REF		



Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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